

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
HAI LONG JIA	02/22/2016
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<b>Postal Code:</b>	201203
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<b>Postal Code:</b>	100176
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	15066973
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<b>SIGNATURE:</b>	/Yi-Ming Tseng/
<b>DATE SIGNED:</b>	03/10/2016
<b>Total Attachments: 1</b> source=20160310_SMIC00091US_Assignment_EF#page1.tif	

CLIENT REFERENCE NO.: 2015-01166-SH-US  
ATTORNEY DOCKET NO.: SMIC00091 US

**ASSIGNMENT**

For good and valuable consideration, receipt of which is hereby acknowledged, we

Hai Long JIA of 18 Zhangjiang Road  
Pudong New Area  
Shanghai, P.R.C. 201203

hereby sell, assign and transfer to **Semiconductor Manufacturing International (Shanghai) Corporation**, having a place of business at 18 Zhangjiang Road, Pudong New Area, Shanghai, P.R.C. 201203, and, **Semiconductor Manufacturing International (Beijing) Corporation**, having a place of business at 18 Wenchang Road, Beijing Economic-Technological Development Area, Beijing, China, 100176, its successors and assigns, the entire right, title and interest throughout the world in my invention in

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for which I have executed a United States patent application on or about the date of this assignment, and all patent applications and patents of every country for said invention, including divisionals, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of said applications; I authorize the above-named assignee to apply for patents of foreign countries for said invention, and to claim all rights of priority without further authorization from me; I agree to execute all papers useful in connection with said United States and foreign applications, and generally to do everything possible to aid said assignee, its successors, assigns and nominees, at their request and expense, in obtaining and enforcing patents for said invention in all countries; and I request that the United States Patent and Trademark Office issue all patents granted for said invention to the above-named assignee, its successors and assigns.

Executed this 22<sup>th</sup> day of Feb., 2016.

Hai Long JIA  
Hai Long JIA

WITNESSED:

Jeff Zhu

Signature Jeff Zhu

Date 2016/2/22

Type or print name of witness